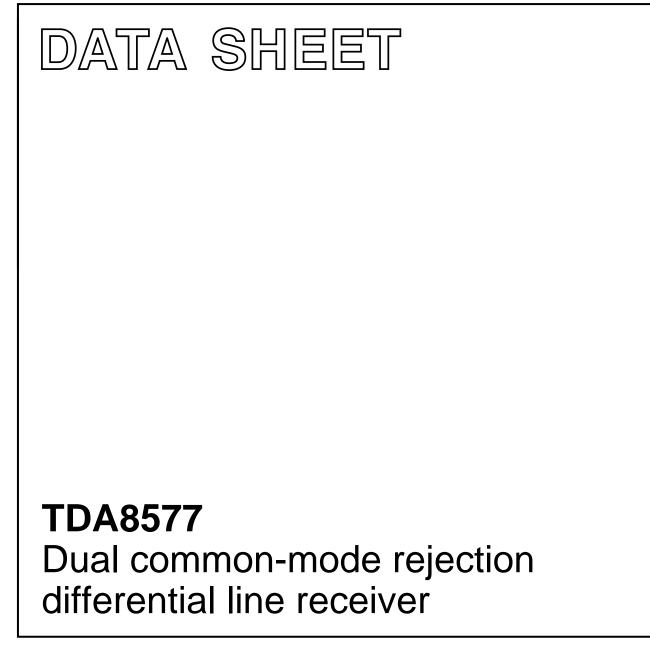
INTEGRATED CIRCUITS



Preliminary specification File under Integrated Circuits, IC01 September 1995

**Philips Semiconductors** 





### **TDA8577**

### FEATURES

- Excellent common-mode rejection, up to high frequencies
- Elimination of source resistance dependency in the common-mode rejection
- · Few external components
- High supply voltage ripple rejection
- Low noise
- Low distortion
- All pins protected against electrostatic discharge
- AC and DC short-circuit safe to ground and V<sub>CC</sub>
- · Fast DC settling.

#### QUICK REFERENCE DATA

### **GENERAL DESCRIPTION**

The TDA8577 is a two channel differential amplifier with 0 dB gain and low distortion. The device has been primarily developed for car radio applications where long connections between signal sources and amplifiers (or boosters) are necessary and where ground noise has to be eliminated. The device is intended to be used to receive line inputs in audio applications that require a high level of common-mode rejection. The device is contained in a 9-pin single in-line package.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>CC</sub>	supply voltage		5.0	8.5	18	V
I <sub>CC</sub>	supply current	V <sub>CC</sub> = 8.5	-	11	14	mA
Gv	voltage gain		-0.5	0	+0.5	dB
SVRR	supply voltage ripple rejection		55	60	-	dB
V <sub>no</sub>	noise output voltage		-	3.7	5.0	μV
Z <sub>i</sub>	input impedance		100	240	-	kΩ
CMRR	common-mode rejection ratio	$R_s = 0 \Omega$	-	80	-	dB

#### **ORDERING INFORMATION**

EXTENDED TYPE	PACKAGE				
NUMBER	PINS	PIN POSITION	MATERIAL	CODE	
TDA8577	9	SIL9	plastic	SOT142	

FUNCTIONAL DESCRIPTION

capacitor within 0.2 seconds.

The TDA8577 contains two identical differential amplifiers with a voltage gain of 0 dB. The device is intended to receive line input signals for audio applications. The

TDA8577 has a very high level of common-mode rejection and thus eliminates ground noise. The common-mode rejection remains constant up to high frequencies (the

amplifier gain is fixed at 0 dB). The inputs have a high input

impedance. The output stage is a class AB stage with a low output impedance. For a large common-mode rejection, also at low frequencies, an electrolytic capacitor

connected to the negative input is advised. Because the input impedance is relatively high, this results in a large settling time of the DC input voltage. Therefore a

quick-charge circuit is included to charge the input

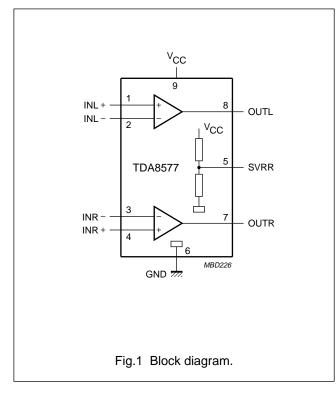
All input and output pins are protected against high

electrostatic discharge conditions (4000 V, 150 pF, 150  $\Omega$ ).

### Dual common-mode rejection differential line receiver

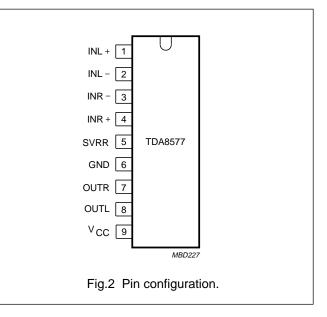
### TDA8577

### **BLOCK DIAGRAM**



### PINNING

SYMBOL	PIN	DESCRIPTION	
INL+	1	positive input left	
INL-	2	negative input left	
INR-	3	negative input right	
INR+	4	positive input right	
SVRR	5	half supply voltage	
GND	6	ground	
OUTR	7	output right	
OUTL	8	output left	
V <sub>CC</sub>	9	supply voltage	



### TDA8577

### LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>CC</sub>	supply voltage	operating	-	18	V
I <sub>ORM</sub>	repetitive peak output current		-	40	mA
V <sub>sc</sub>	AC and DC short-circuit safe voltage		-	18	V
T <sub>stg</sub>	storage temperature		-55	+150	°C
T <sub>amb</sub>	operating ambient temperature		-40	+85	°C
Tj	maximum junction temperature		_	+150	°C

#### THERMAL RESISTANCE

SYMBOL	PARAMETER	THERMAL RESISTANCE		
R <sub>th j-a</sub>	from junction to ambient in free air	80 K/W		

### TDA8577

### CHARACTERISTICS

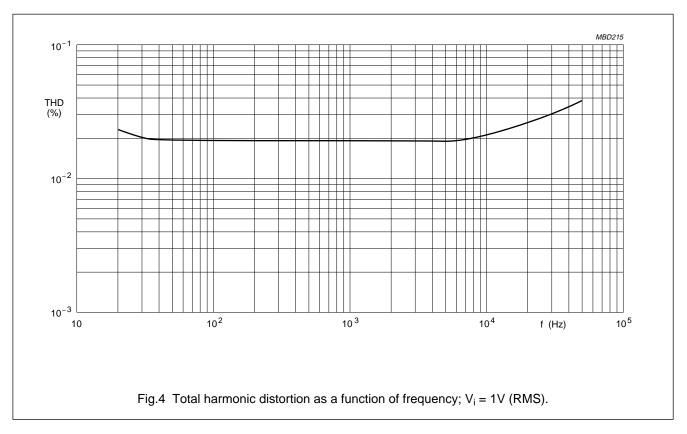
V<sub>CC</sub> = 8.5 V; T<sub>amb</sub> = 25 °C; f = 1 kHz; measured in test circuit of Fig.3; unless otherwise specified.

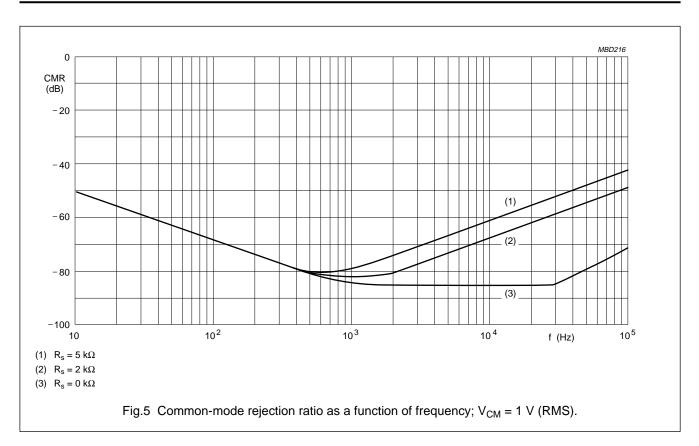
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>CC</sub>	supply voltage		5.0	8.5	18	V
I <sub>CC</sub>	supply current		-	11	14	mA
Vo	DC output voltage	note 1	-	4.3	_	V
t <sub>set</sub>	DC input voltage settling time		-	0.2	_	S
G <sub>v</sub>	voltage gain		-0.5	0	+0.5	dB
α <sub>cs</sub>	channel separation	$R_s = 5 k\Omega$	70	80	_	dB
ΔG <sub>v</sub>	channel unbalance		_	_	0.5	dB
fL	low frequency roll-off	-1 dB; note 2	20	_	_	Hz
f <sub>H</sub>	high frequency roll-off	-1 dB	20	_	_	kHz
Z <sub>i</sub>	input impedance		100	240	_	kΩ
Z <sub>o</sub>	output impedance		-	_	10	Ω
V <sub>i(max)</sub>	maximum input voltage	THD = 1%	_	2	_	V
V <sub>no</sub>	noise output voltage	$R_s = 0 \Omega$ ; note 3	_	3.7	5.0	μV
V <sub>CM(rms)</sub>	common-mode input voltage (RMS value)		-	-	1	V
CMRR	common-mode rejection ratio	$R_s = 5 k\Omega$	66	70	_	dB
		$R_s = 0 \Omega$ ; note 4	-	80	_	dB
SVRR	supply voltage ripple rejection	note 5	55	65	_	dB
		note 6	-	60	_	dB
THD	total harmonic distortion	V <sub>i</sub> = 1 V;	-	0.02	-	%
		$V_i = 1 V;$ f = 20 Hz to 20 kHz	-	-	0.1	%
THD <sub>max</sub>	total harmonic distortion at maximum output current	$V_i = 1 V; R_L = 150 \Omega$	-	-	1	%

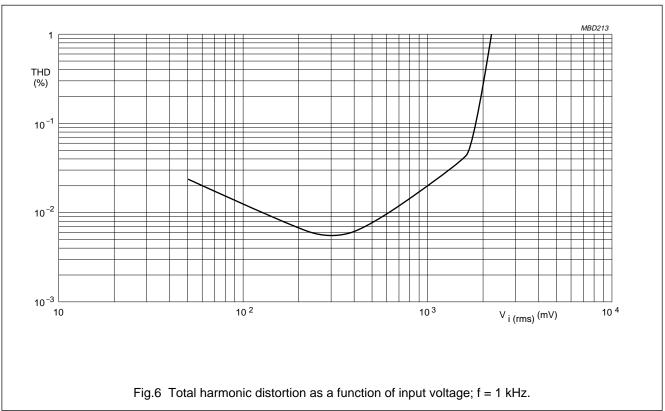
#### Notes

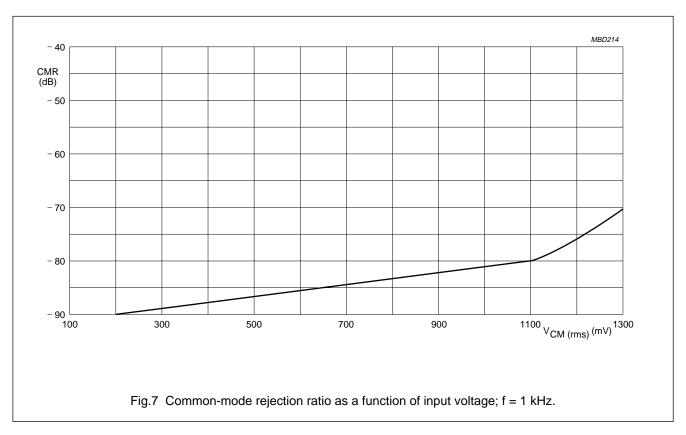
- 1. The DC output voltage with respect to ground is approximately  $0.5V_{CC}$ .
- 2. The frequency response is externally fixed by the input coupling capacitors.
- 3. The noise output voltage is measured in a bandwidth of 20 Hz to 20 kHz (unweighted).
- 4. The common-mode rejection ratio is measured at the output with a voltage source of 1 V (RMS) in accordance with the test circuit (see Fig.3) while V<sub>INL</sub> and V<sub>INR</sub> are shorted-circuited. Frequencies between 100 Hz and 100 kHz.
- 5. The ripple rejection is measured at the output, with  $R_s = 2 k\Omega$ , f = 1 kHz and a ripple amplitude of 2 V (p-p).
- The ripple rejection is measured at the output, with R<sub>s</sub> = 0 to 2 kΩ, f = 100 Hz to 20 kHz and a maximum ripple amplitude of 2 V (p-p).

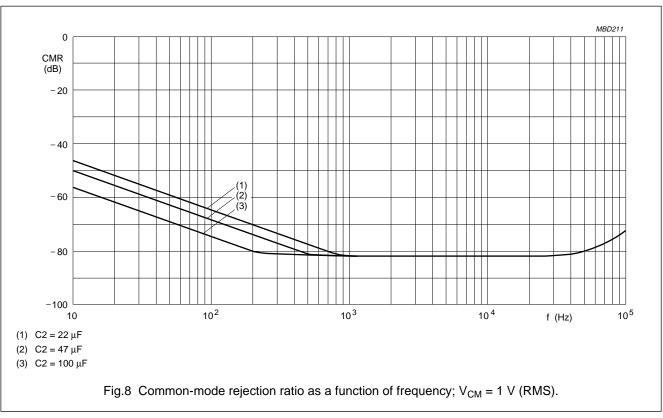
#### - 8.5 V 100 nF 220 nF $R_s$ 9 łŀ 2.2 μF VINL 1 5 kΩ 8 +\_]**|** OUTL $\sim$ ( 2 Vcc 22 μF 47 μF TDA8577 5 +\_]| ┨┠╧ SVRR 3 Г $^{\sf V}$ CM V<sub>INR</sub> 2.2 μF 7 +\_]| OUTR $\sim$ R<u>s</u> 220 nF 4 $\Box_{\underline{6}}$ RL R∟ -H 5kΩ $10 \text{ k}\Omega$ \_\_\_\_\_10 kΩ MBD229 777. Fig.3 Test circuit.

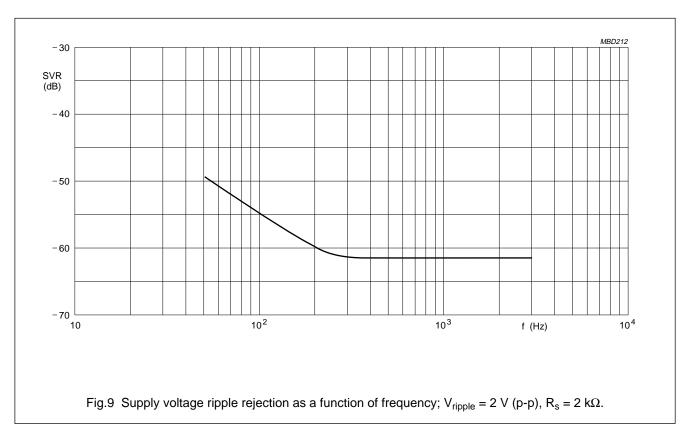




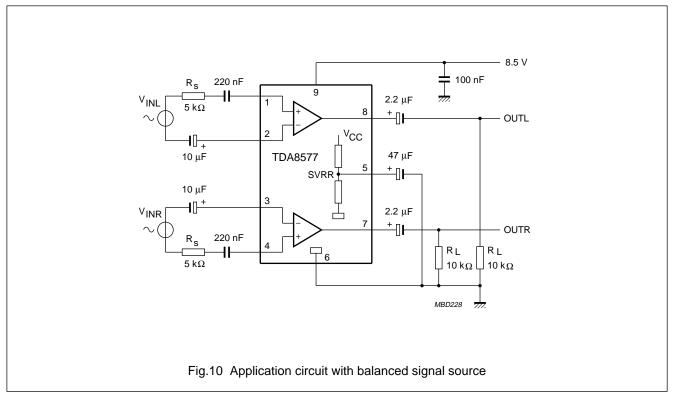






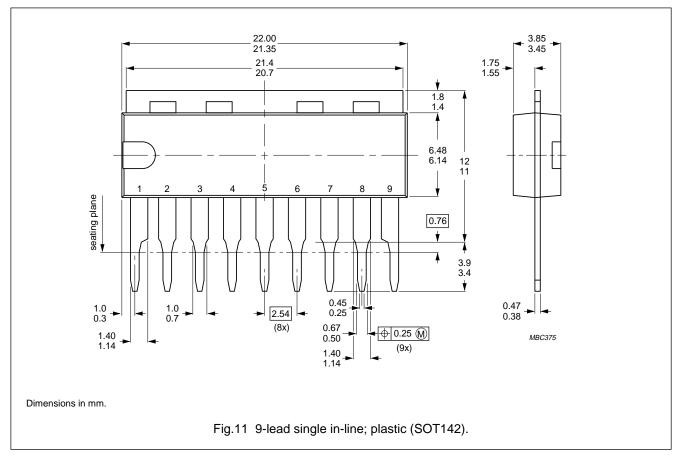


### APPLICATION INFORMATION



### TDA8577

### PACKAGE OUTLINE



### SOLDERING

#### Plastic single in-line packages

#### BY DIP OR WAVE

The maximum permissible temperature of the solder is 260 °C; this temperature must not be in contact with the joint for more than 5 s. The total contact time of successive solder waves must not exceed 5 s.

The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified storage maximum. If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature within the permissible limit.

#### REPAIRING SOLDERED JOINTS

Apply the soldering iron below the seating plane (or not more than 2 mm above it). If its temperature is below 300 °C, it must not be in contact for more than 10 s; if between 300 and 400 °C, for not more than 5 s.

#### Preliminary specification

TDA8577

### DEFINITIONS

Data sheet status				
Objective specification	cification This data sheet contains target or goal specifications for product development.			
Preliminary specification	pecification This data sheet contains preliminary data; supplementary data may be published later.			
Product specification	This data sheet contains final product specifications.			
Limiting values	Limiting values			
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.				
Application information				

Where application information is given, it is advisory and does not form part of the specification.

### LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

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